

120V N-Ch Power MOSFET

Feature

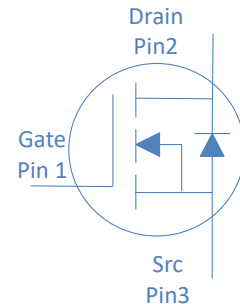
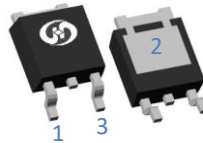
- ◇ High Speed Power Switching, Logic Level
- ◇ Enhanced Body diode dv/dt capability
- ◇ Enhanced Avalanche Ruggedness
- ◇ 100% UIS Tested, 100% Rg Tested
- ◇ Lead Free, Halogen Free

V_{DS}		120	V
$R_{DS(on),typ}$	$V_{GS}=10V$	7.5	m Ω
$R_{DS(on),typ}$	$V_{GS}=4.5V$	9.3	m Ω
I_D (Silicon Limited)		81	A

Application

- ◇ Synchronous Rectification in SMPS
- ◇ Hard Switching and High Speed Circuit
- ◇ DC/DC in Telecoms and Industrial

TO-252



Part Number	Package	Marking
HGD093N12SL	TO-252	GD093N12SL

Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ (unless otherwise specified)

Parameter	Symbol	Conditions	Value	Unit
Continuous Drain Current (Silicon Limited)	I_D	$T_C=25^\circ\text{C}$	81	A
		$T_C=100^\circ\text{C}$	57	
Drain to Source Voltage	V_{DS}	-	120	V
Gate to Source Voltage	V_{GS}	-	± 20	V
Pulsed Drain Current	I_{DM}	-	250	A
Avalanche Energy, Single Pulse	E_{AS}	$L=0.1\text{mH}, T_C=25^\circ\text{C}$	101	mJ
Power Dissipation	P_D	$T_C=25^\circ\text{C}$	143	W
Operating and Storage Temperature	T_J, T_{stg}	-	-55 to 175	$^\circ\text{C}$

Absolute Maximum Ratings

Parameter	Symbol	Max	Unit
Thermal Resistance Junction-Ambient	$R_{\theta JA}$	46	$^\circ\text{C}/\text{W}$
Thermal Resistance Junction-Case	$R_{\theta JC}$	1.05	$^\circ\text{C}/\text{W}$

Electrical Characteristics at T_j=25°C (unless otherwise specified)
Static Characteristics

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
Drain to Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	120	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _D =250μA	1.4	2	2.4	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} =0V, V _{DS} =120V, T _j =25°C	-	-	1	μA
		V _{GS} =0V, V _{DS} =120V, T _j =100°C	-	-	100	
Gate to Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Drain to Source on Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A	-	7.5	9.3	mΩ
		V _{GS} =4.5V, I _D =10A	-	9.3	12.5	
Transconductance	g _{fs}	V _{DS} =5V, I _D =20A	-	70	-	S
Gate Resistance	R _G	V _{GS} =0V, V _{DS} Open, f=1MHz	-	1	-	Ω

Dynamic Characteristics

Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =60V, f=1MHz	-	2626	-	pF
Output Capacitance	C _{oss}		-	329	-	
Reverse Transfer Capacitance	C _{rss}		-	11	-	
Total Gate Charge	Q _g (10V)	V _{DD} =60V, I _D =20A, V _{GS} =10V	-	38	-	nC
Total Gate Charge	Q _g (4.5V)		-	18	-	
Gate to Source Charge	Q _{gs}		-	7	-	
Gate to Drain (Miller) Charge	Q _{gd}		-	5	-	
Turn on Delay Time	t _{d(on)}	V _{DD} =60V, I _D =20A, V _{GS} =10V, R _G =10Ω,	-	13	-	ns
Rise time	t _r		-	7	-	
Turn off Delay Time	t _{d(off)}		-	22	-	
Fall Time	t _f		-	9	-	

Reverse Diode Characteristics

Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _F =20A	-	0.9	1.2	V
Reverse Recovery Time	t _{rr}	V _R =60V, I _F =20A, dI _F /dt=100A/μs	-	53	-	ns
Reverse Recovery Charge	Q _{rr}		-	58	-	nC

Fig 1. Typical Output Characteristics

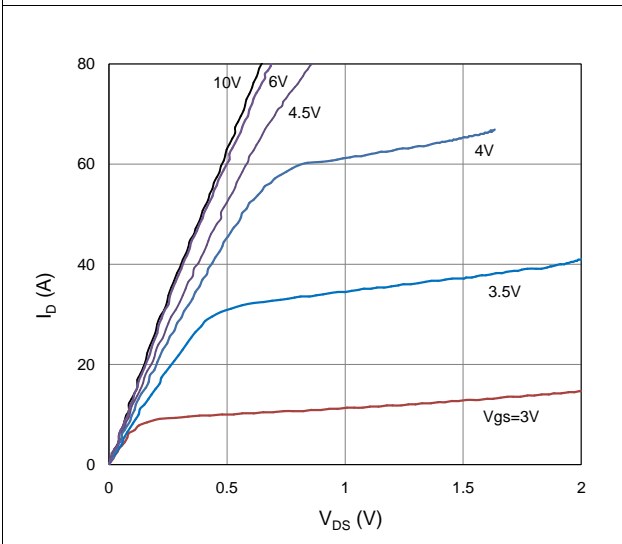


Figure 2. On-Resistance vs. Gate-Source Voltage

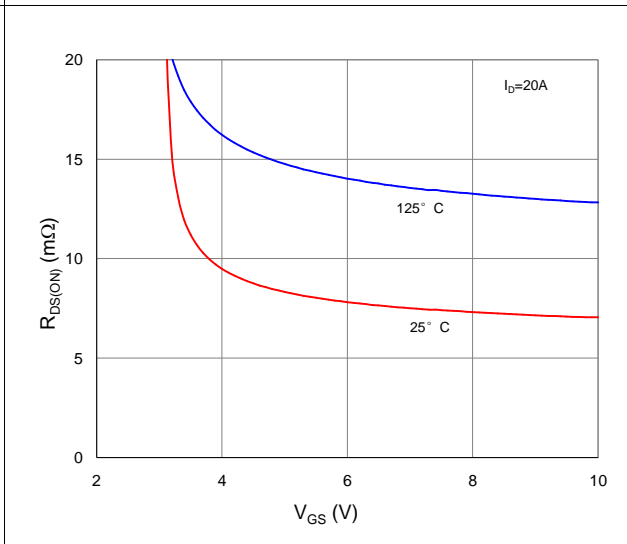


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

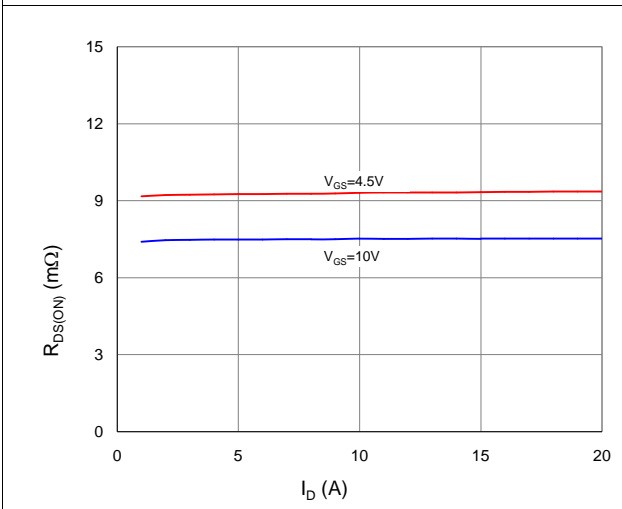


Figure 4. Normalized On-Resistance vs. Junction Temperature

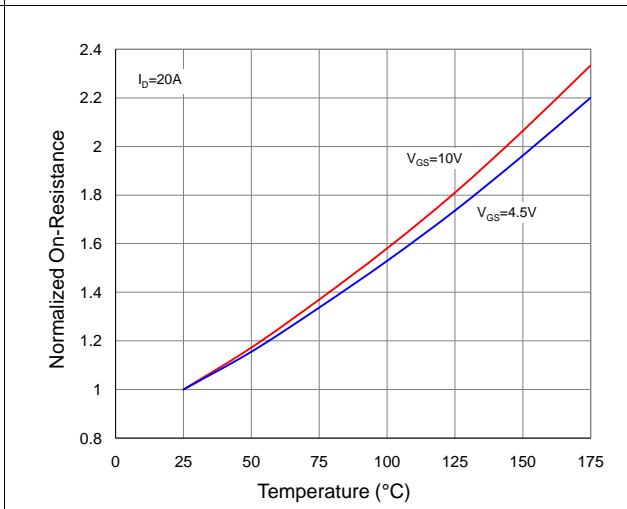


Figure 5. Typical Transfer Characteristics

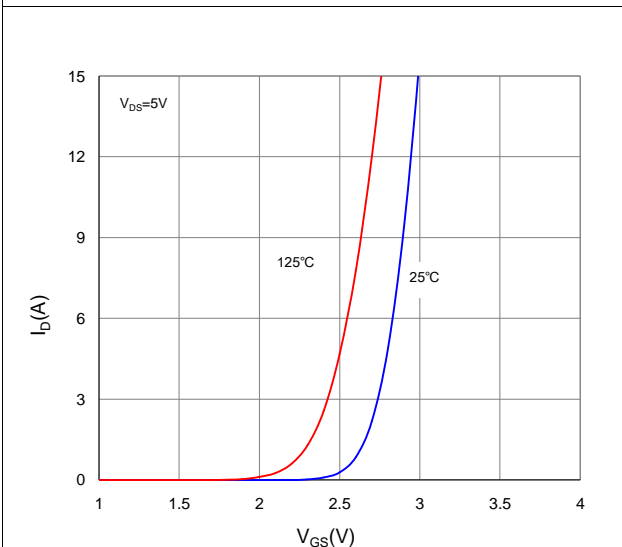


Figure 6. Typical Source-Drain Diode Forward Voltage

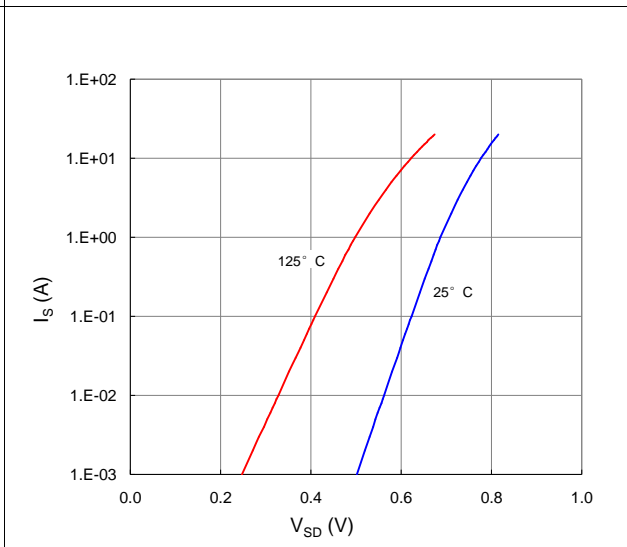


Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

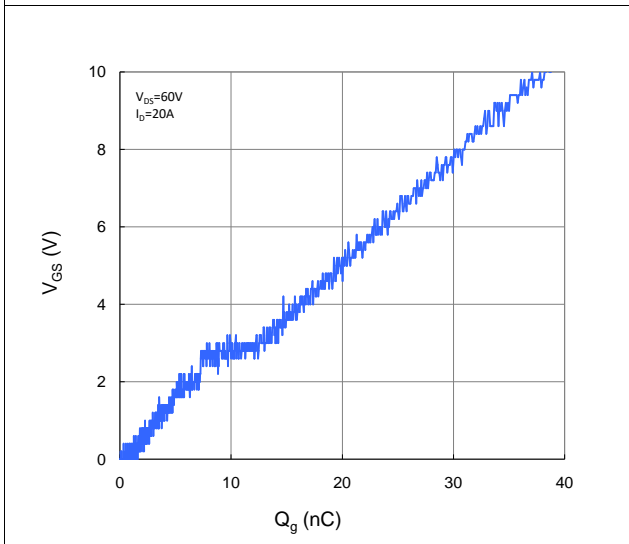


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

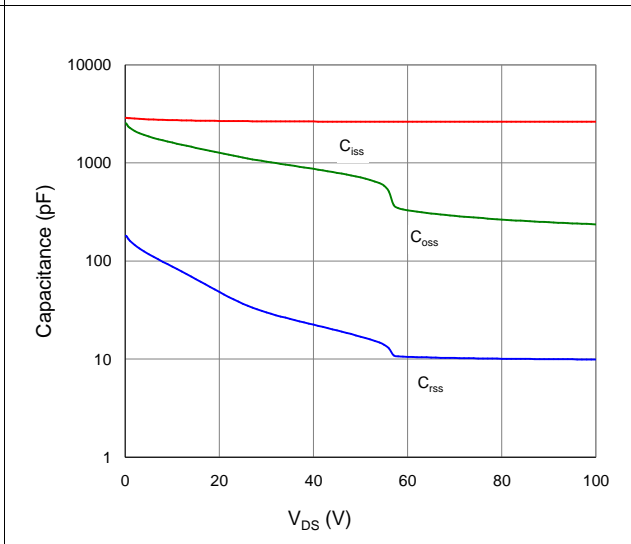


Figure 9. Maximum Safe Operating Area

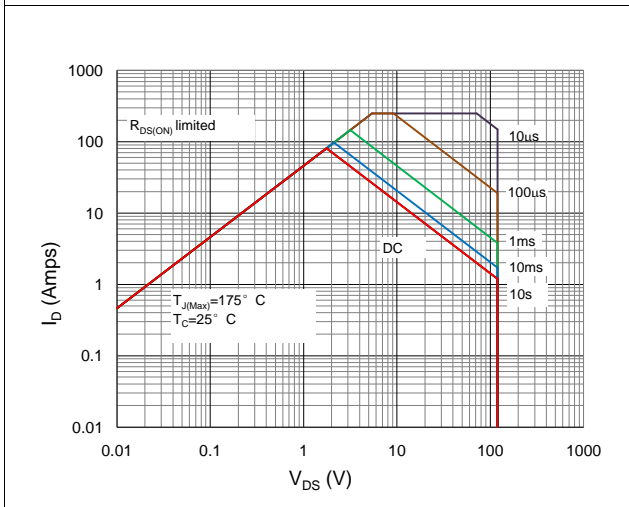


Figure 10. Maximum Drain Current vs. Case Temperature

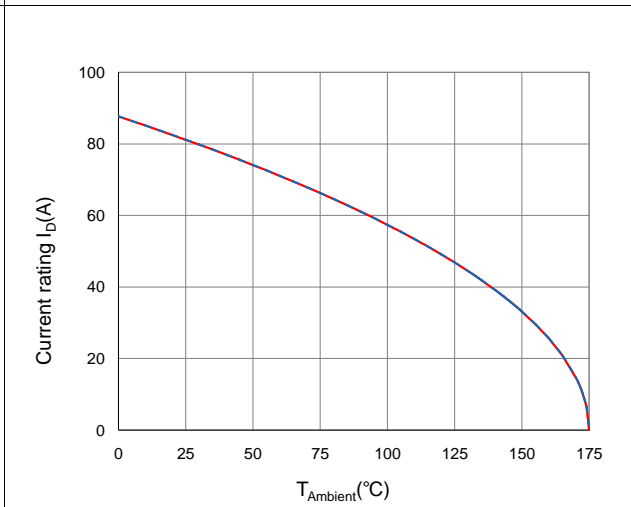
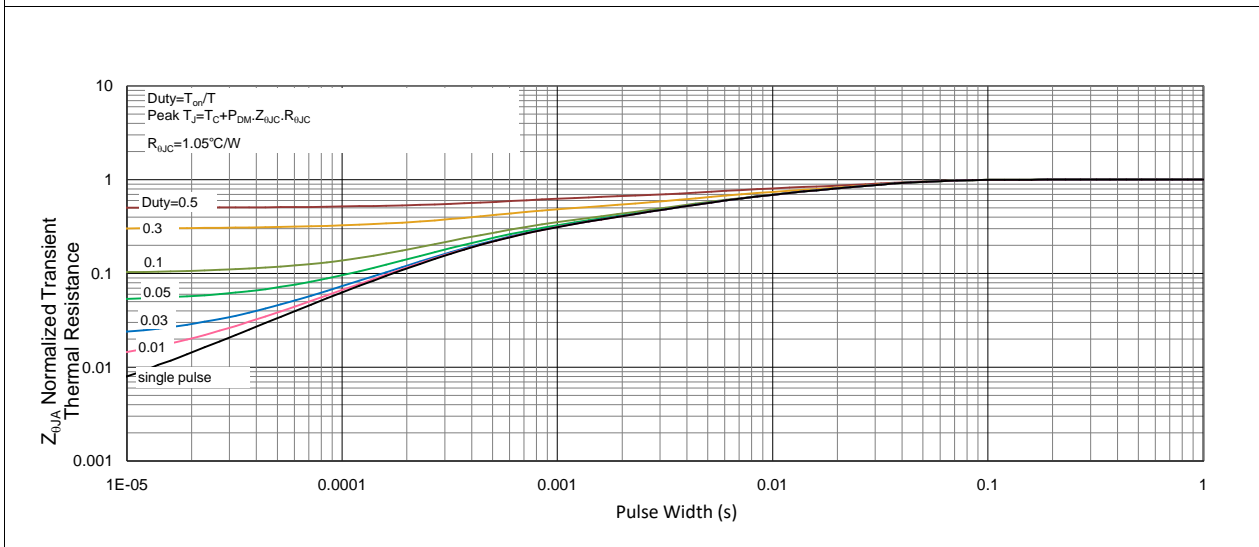
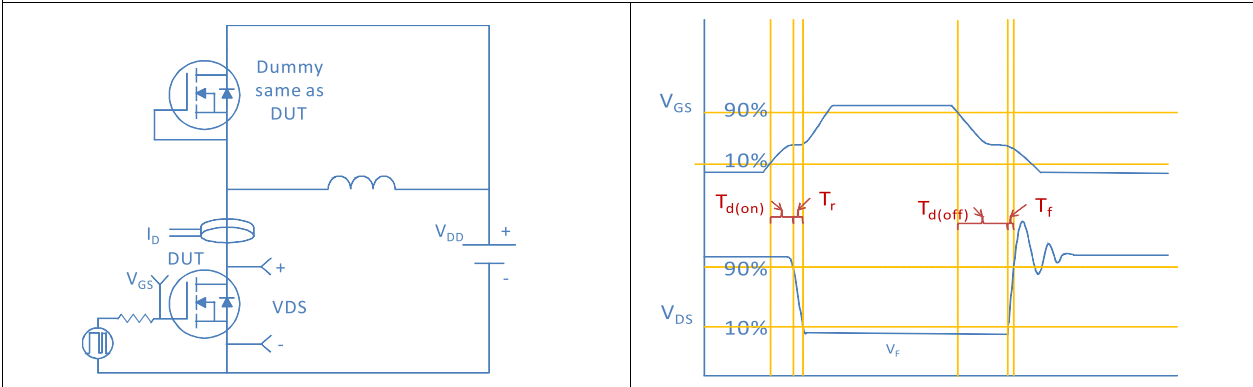


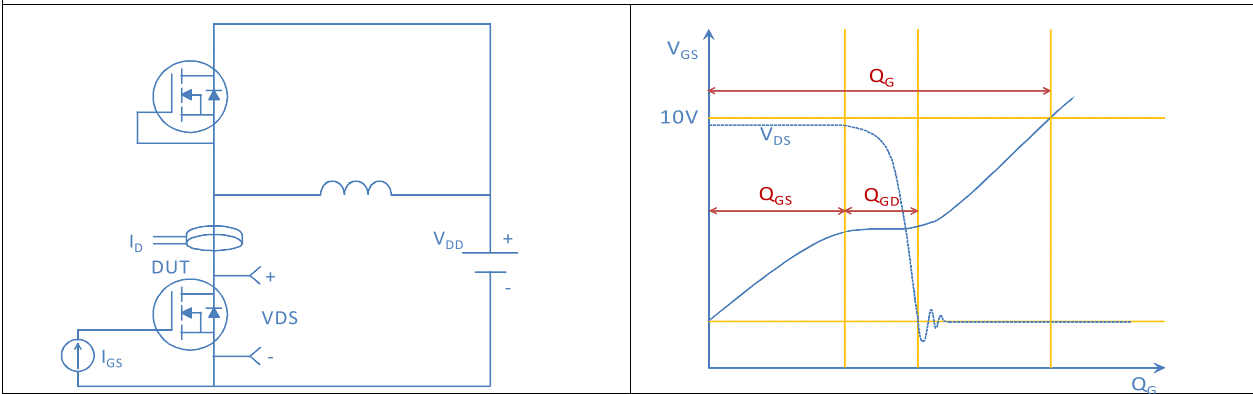
Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Ambient



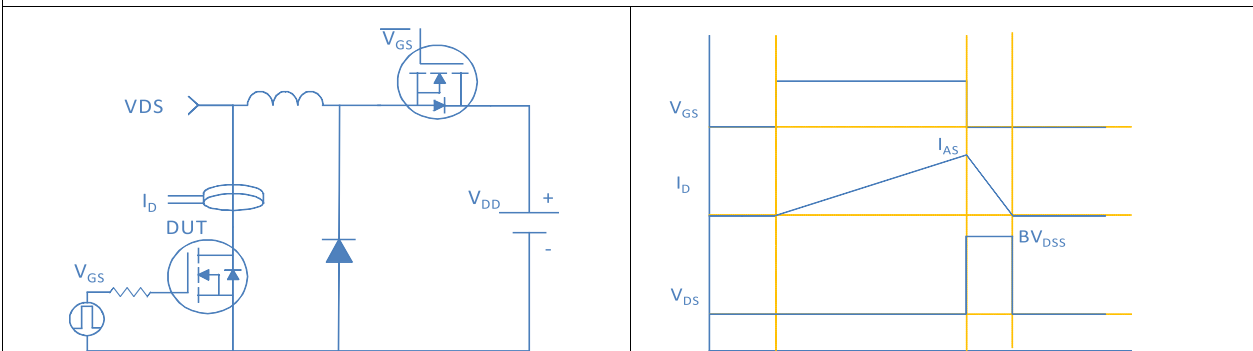
Inductive switching Test



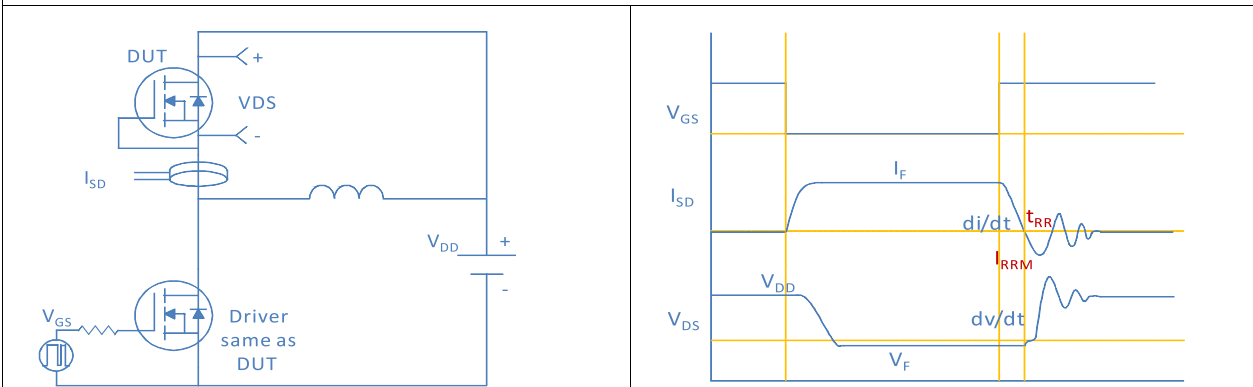
Gate Charge Test



Uclamped Inductive Switching (UIS) Test

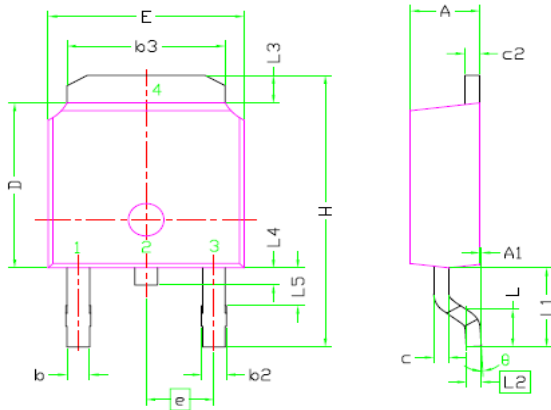


Diode Recovery Test



Package Outline

TO-252, 2 leads



SYMBOL	DIMENSIONAL REQMTS		
	MIN	NOM	MAX
E	6.40	6.60	6.731
L	1.40	1.52	1.77
L1	2.743 REF		
L2	0.508 BSC		
L3	0.89	--	1.27
L4	0.64	--	1.01
L5	--	--	--
D	6.00	6.10	6.223
H	9.40	10.00	10.40
b	0.64	0.76	0.88
b2	0.77	0.84	1.14
b3	5.21	5.34	5.46
e	2.286 BSC		
A	2.20	2.30	2.38
A1	0	--	0.127
c	0.46	0.50	0.60
c2	0.46	0.50	0.58
D1	5.21	--	--
E1	4.40	--	--
θ	0°	--	10°

